

Panasonic

DRA3115E0L

Silicon PNP epitaxial planar type

For digital circuits

Complementary to DRC3115E

DRA9115E in SSSMini3 type package

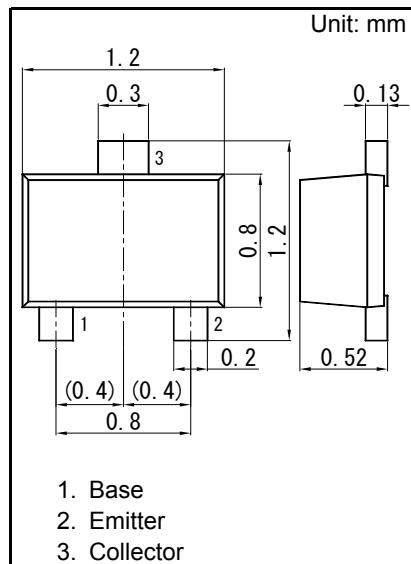
■ Features

- Low collector-emitter saturation voltage $V_{ce(sat)}$
- Halogen-free / RoHS compliant
(EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)

■ Marking Symbol: LN

■ Packaging

Embossed type (Thermo-compression sealing) : 10 000 pcs / reel (standard)

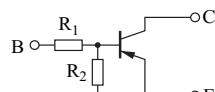


Panasonic	SSSMini3-F2-B
JEITA	SC-105AA
Code	SOT-723

■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	VCBO	-50	V
Collector-emitter voltage (Base open)	VCEO	-50	V
Collector current	IC	-100	mA
Total power dissipation	PT	100	mW
Junction temperature	T _j	150	°C
Operating ambient temperature	T _{opr}	-40 to +85	°C
Storage temperature	T _{stq}	-55 to +150	°C

Internal Connection



Resistance value	R1	100	kΩ
	R2	100	kΩ

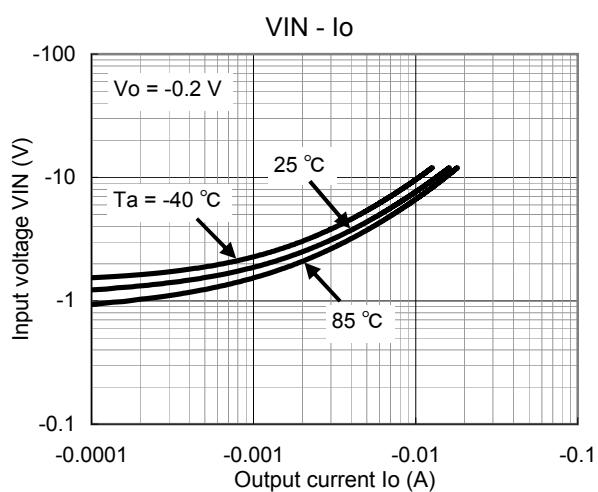
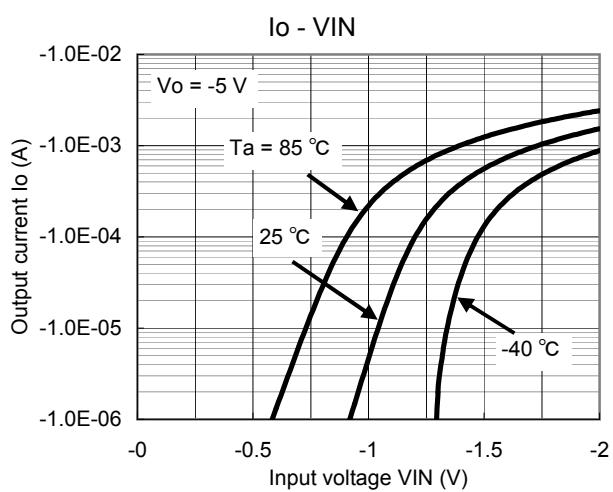
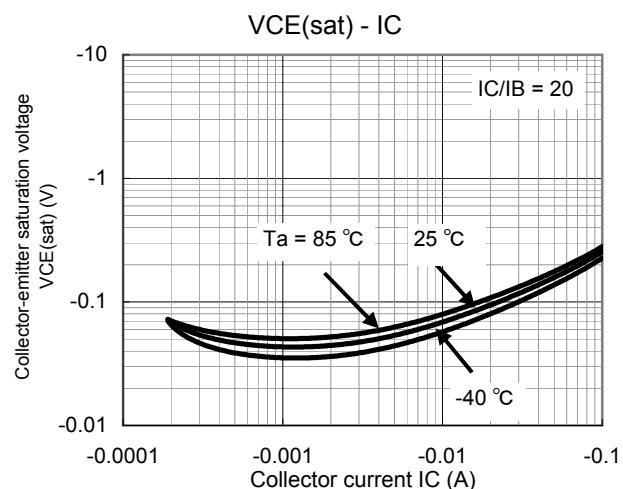
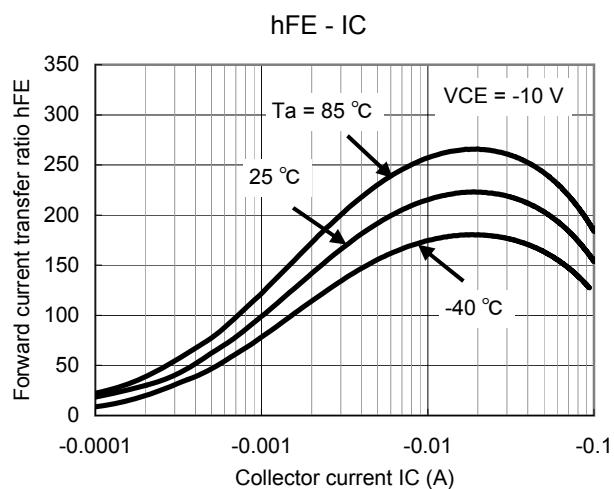
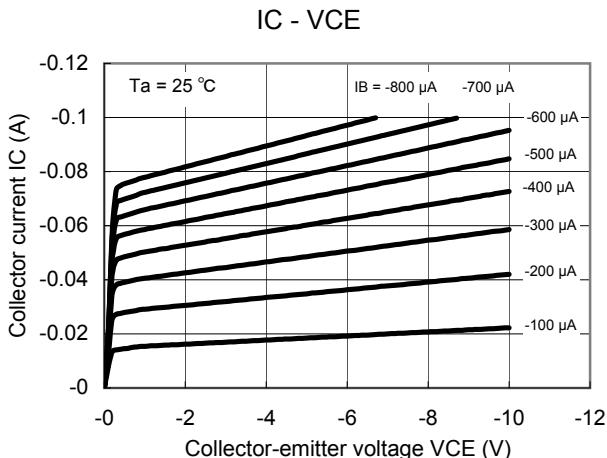
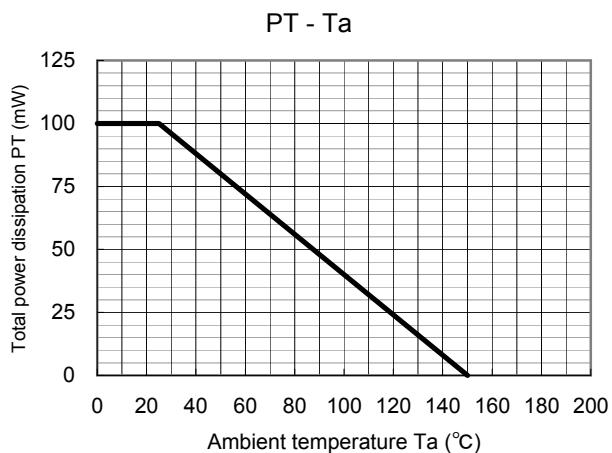
■ Electrical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector-base voltage (Emitter open)	VCBO	IC = -10 μ A, IE = 0	-50			V
Collector-emitter voltage (Base open)	VCEO	IC = -2 mA, IB = 0	-50			V
Collector-base cutoff current (Emitter open)	ICBO	VCB = -50 V, IE = 0			-0.1	μ A
Collector-emitter cutoff current (Base open)	ICEO	VCE = -50 V, IB = 0			-0.5	μ A
Emitter-base cutoff current (Collector open)	IEBO	VEB = -6 V, IC = 0			-0.1	mA
Forward current transfer ratio	hFE	VCE = -10 V, IC = -5 mA	80			-
Collector-emitter saturation voltage	VCE(sat)	IC = -10 mA, IB = -0.5 mA			-0.25	V
Input voltage	Vi(on)	VCE = -0.2 V, IC = -5 mA	-5.7			V
	Vi(off)	VCE = -5 V, IC = -100 μ A			-0.8	V
Input resistance	R1		-30%	100	+30%	k Ω
Resistance ratio	R1/R2		0.8	1.0	1.2	-

Note 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 Measuring methods for transistors.



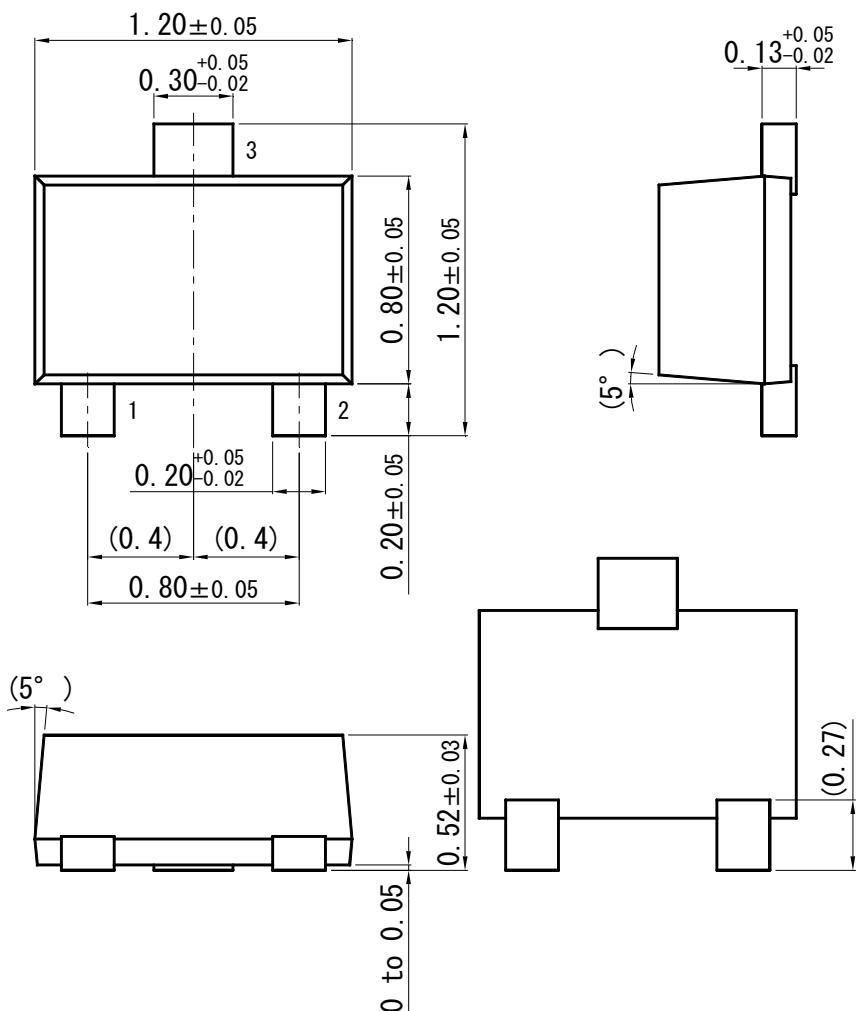
Technical Data (reference)



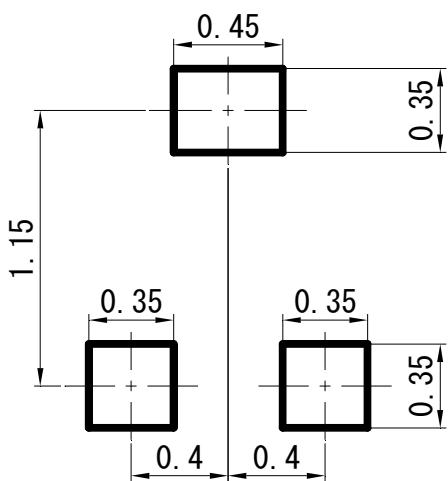
Panasonic

SSSMini3-F2-B

Unit: mm



■ Land Pattern (Reference) (Unit: mm)



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